



**DUAL 15V NPN & 12V PNP LOW SATURATION TRANSISTOR COMBINATION** 

#### Features

#### NPN Transistor

- $BV_{CEO} > 15V$ 
  - I<sub>C</sub> = 4.5A Continuous Collector Current
- Low Saturation Voltage (100mV max @ 1A) .
- $R_{SAT} = 45m\Omega$  for a low equivalent On-Resistance •

**PNP** Transistor

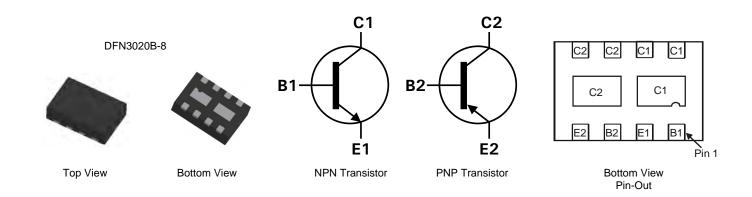
- $BV_{CEO} > -12V$ ٠
- I<sub>C</sub> = -4A Continuous Collector Current ٠
- Low Saturation Voltage (-140mV max @ -1A) ٠
- $R_{SAT} = 60m\Omega$  for a low equivalent On-Resistance
- hFF characterized up to 12A for high current gain hold up .
- Low profile 0.8mm high package for thin applications
- $R_{\theta JA}$  efficient, 40% lower than SOT26
- 6mm<sup>2</sup> footprint, 50% smaller than TSOP6 and SOT26 •
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: DFN3020B-8
- Case material: Molded Plastic. "Green" Molding Compound.
- Terminals: Pre-Plated NiPdAu leadframe.
- Nominal package height: 0.8mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.013 grams (approximate)

### **Applications**

- DC DC Converters
- Charging circuits
- Power switches
- Motor control
- LED Backlighting circuits
- Portable applications



### **Ordering Information**

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC6717MCTA	DA1	7	8	3000

Notes: 1. No purposefully added lead.

2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com.

### **Marking Information**



DA1 = Product type Marking Code Dot denotes Pin 1



#### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic		Symbol	NPN	PNP	Unit
Collector-Base Voltage		V <sub>CBO</sub>	40	-20	V
Collector-Emitter Voltage		V <sub>CEO</sub>	15	-12	V
Emitter-Base Voltage		V <sub>EBO</sub>	7	-7	V
Peak Pulse Current		I <sub>CM</sub>	15	-12	A
Continuous Collector Current	(Notes 3 & 6)	- I <sub>C</sub>	4.5	-4	٨
	(Notes 4 & 6)		5	-4.45	A
Base Current		Ι <sub>Β</sub>		1	A

# Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	NPN	PNP	Unit	
	(Notes 3 & 6)		1.5 12 2.45 19.6 1.13 8 1.7 13.6		₩ mW/°C
Power Dissipation Linear Derating Factor	(Notes 4 & 6)	5			
	(Notes 5 & 6)	PD			
	(Notes 5 & 7)				
	(Notes 3 & 6)		83.3 51.0 111 73.5 17.1		°C/W
Thermal Desistance, hunsting to Ambient	(Notes 4 & 6)	_			
Thermal Resistance, Junction to Ambient	(Notes 5 & 6)	$R_{ extsf{ heta}JA}$			
	(Notes 5 & 7)				
Thermal Resistance, Junction to Lead	(Notes 6 & 8)	R <sub>θJL</sub>			
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +	150	°C

Notes: 3. For a dual device surface mounted on 28mm x 28mm (8cm<sup>2</sup>) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector pads connected to each half.

4. Same as note (3), except the device is measured at t <5 sec.

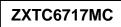
5. Same as note (3), except the device is surface mounted on 31mm x 31mm (10cm<sup>2</sup>) FR4 PCB with high coverage of single sided 1oz copper.

6. For a dual device with one active die.

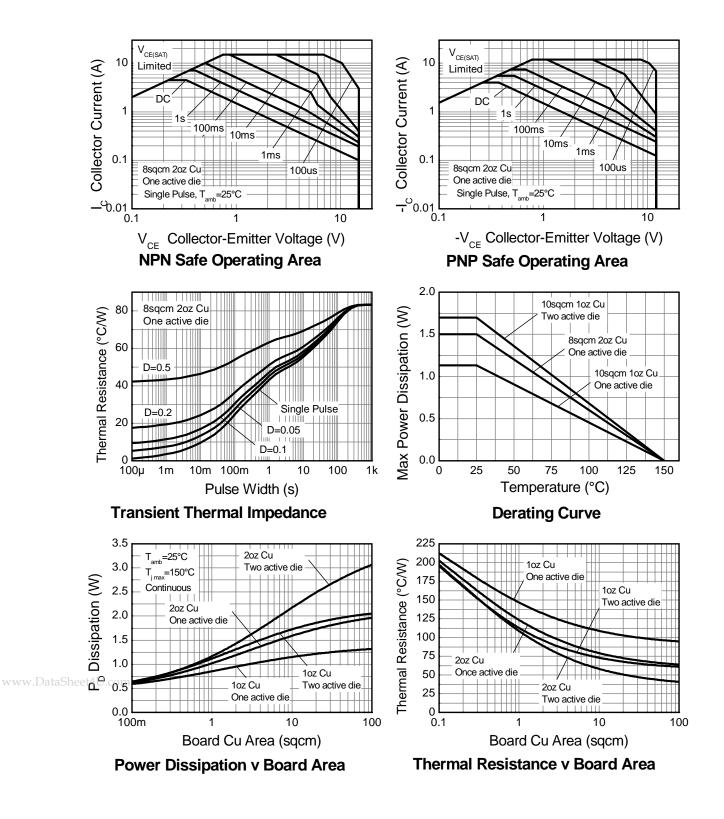
7. For dual device with 2 active die running at equal power.

8. Thermal resistance from junction to solder-point (at the end of the collector lead).





## **Thermal Characteristics**



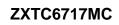


## NPN - Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

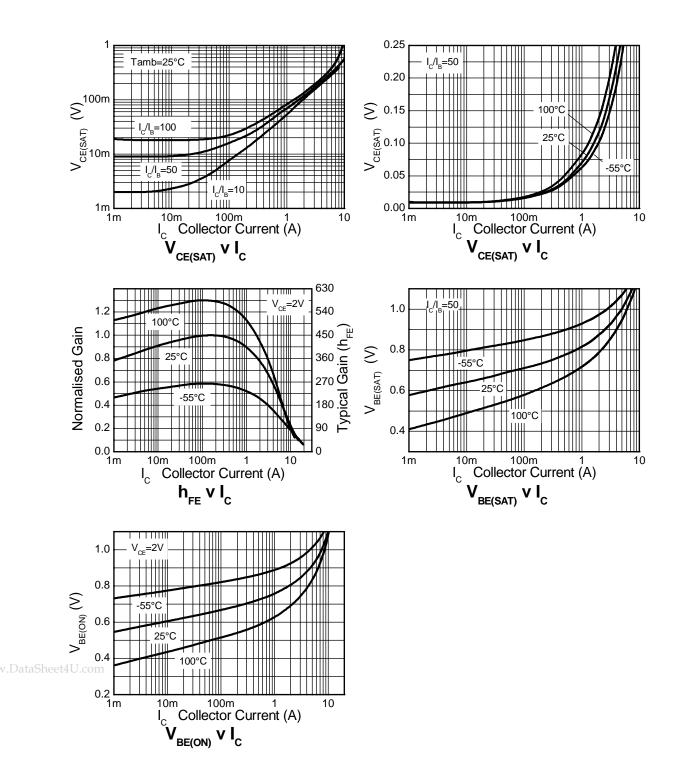
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	40	70	-	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	15	18	-	V	$I_{\rm C} = 10 {\rm mA}$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.2	-	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>СВО</sub>	-	-	100	nA	$V_{CB} = 30V$
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	100	. nA	$V_{EB} = 6V$
Collector Emitter Cutoff Current	ICES	-	-	100	nA	$V_{CE} = 12V$
Static Forward Current Transfer Ratio (Note 9)	hFE	200 300 200 150	415 450 320 240 80	- - - -	-	$\begin{split} I_{C} &= 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 200 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 3 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 5 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 12 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 9)	V <sub>CE(sat)</sub>	-	8 70 165 240 200	14 100 200 310 -	mV	$\begin{split} I_{C} &= 0.1A, \ I_{B} = 10 mA \\ I_{C} &= 1A, \ I_{B} = 10 mA \\ I_{C} &= 3A, \ I_{B} = 50 mA \\ I_{C} &= 4.5A, \ I_{B} = 50 mA \\ I_{C} &= 4.5A, \ I_{B} = 100 mA \end{split}$
Base-Emitter Turn-On Voltage (Note 9)	V <sub>BE(on)</sub>	-	0.88	0.96	V	$I_{C} = 4.5A, V_{CE} = 2V$
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(sat)</sub>	-	0.94	1.05	V	$I_{\rm C} = 4.5 {\rm A}, I_{\rm B} = 50 {\rm mA}$
Output Capacitance	Cobo	-	30	40	pF	V <sub>CB</sub> = 10V. f = 1MHz
Transition Frequency	f <sub>T</sub>	80	120	-	MHz	$V_{CE} = 10V$ , $I_C = 50mA$ , f = 100MHz
Turn-on Time	t <sub>on</sub>	-	120	-	ns	$V_{CC} = 10V, I_{C} = 1A$
Turn-off Time	t <sub>off</sub>	-	160	-	ns	$I_{B1} = I_{B2} = 10 \text{mA}$

Notes: 9. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.





# NPN – Typical Electrical Characteristics





## **PNP - Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

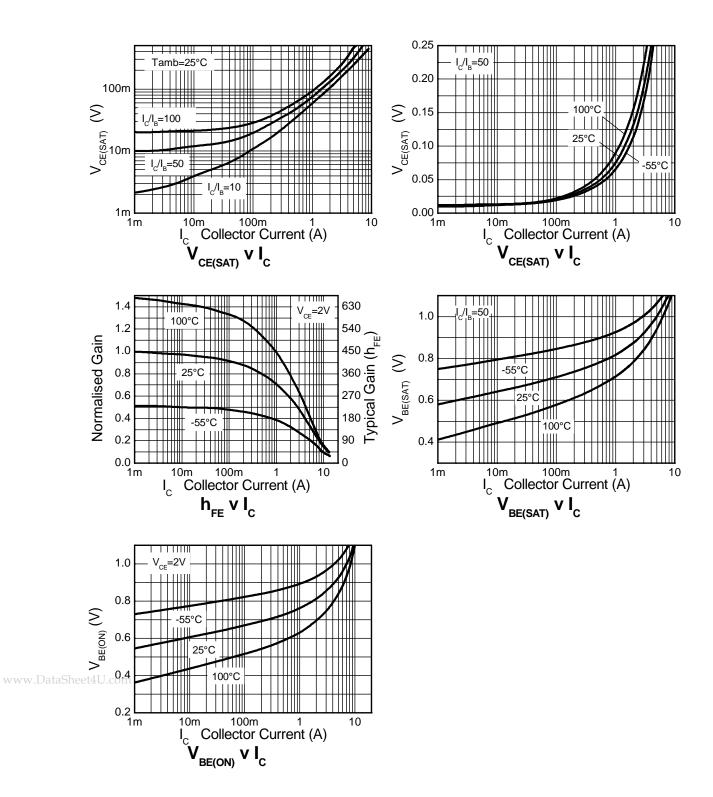
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-20	-35	-	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV <sub>CEO</sub>	-12	-25	-	V	$I_{\rm C} = -10 \mathrm{mA}$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.5	-	V	I <sub>E</sub> = -100μA
Collector Cutoff Current	I <sub>CBO</sub>	-	-	-100	nA	V <sub>CB</sub> = -16V
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	-100	. nA	V <sub>EB</sub> = -6V
Collector Emitter Cutoff Current	I <sub>CES</sub>	-	-	-100	nA	$V_{CES} = -10V$
Static Forward Current Transfer Ratio (Note 10)	h <sub>FE</sub>	300 300 180 60 45	475 450 275 100 70	- - - -	-	$\begin{split} I_{C} &= -10 \text{mA}, \ V_{CE} &= -2 \text{V} \\ I_{C} &= -100 \text{mA}, \ V_{CE} &= -2 \text{V} \\ I_{C} &= -2.5 \text{A}, \ V_{CE} &= -2 \text{V} \\ I_{C} &= -8 \text{A}, \ V_{CE} &= -2 \text{V} \\ I_{C} &= -10 \text{A}, \ V_{CE} &= -2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 10)	V <sub>CE(sat)</sub>		-10 -100 -100 -195 -240	-17 -140 -150 -300 -310	mV	$\label{eq:loss} \begin{array}{l} I_{C} = -0.1A, \ I_{B} = -10mA \\ I_{C} = -1A, \ I_{B} = -10mA \\ I_{C} = -1.5A, \ I_{B} = -50mA \\ I_{C} = -3A, \ I_{B} = -50mA \\ I_{C} = -4A, \ I_{B} = -150mA \end{array}$
Base-Emitter Turn-On Voltage (Note 10)	V <sub>BE(on)</sub>	-	-0.87	-0.96	V	$I_{C} = -4A, V_{CE} = -2V$
Base-Emitter Saturation Voltage (Note 10)	V <sub>BE(sat)</sub>	-	-0.97	-1.07	V	$I_{C} = -4A, I_{B} = -150mA$
Output Capacitance	C <sub>obo</sub>	-	21	30	pF	$V_{CB} = -10V. f = 1MHz$
Transition Frequency	f <sub>T</sub>	100	110	-	MHz	$V_{CE} = -10V, I_C = -50mA, f = 100MHz$
Turn-on Time	t <sub>on</sub>	-	70	-	ns	$V_{CC} = -6V, I_{C} = -2A$
Turn-off Time	t <sub>off</sub>	-	130	-	ns	$I_{B1} = I_{B2} = -50 \text{mA}$

Notes: 10. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.

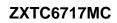




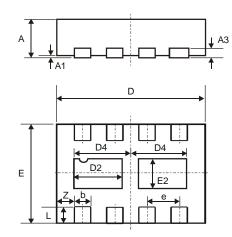
### **PNP – Typical Electrical Characteristics**





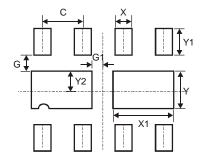


## **Package Outline Dimensions**



	DFN3020B-8						
Dim	Min	Max	Тур				
Α	0.77	0.83	0.80				
A1	0	0.05	0.02				
A3	-	-	0.15				
b	0.25	0.35	0.30				
D	2.95	3.075	3.00				
D2	0.82	1.02	0.92				
D4	1.01	1.21	1.11				
е	-	-	0.65				
ш	1.95	2.075	2.00				
E2	0.43	0.63	0.53				
L	0.25	0.35	0.30				
Z	-	-	0.375				
All I	Dimens	sions ir	n mm				

# Suggested Pad Layout



Dimensions	Value (in mm)
С	0.650
G	0.285
G1	0.090
Х	0.400
X1	1.120
Y	0.730
Y1	0.500
Y2	0.365



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